Preferred Device

# **Surface Mount Schottky Power Rectifier**

This device employs the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system.

#### **Features**

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guard-Ring for Stress Protection
- Pb-Free Package is Available

## **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 217 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- ESD Ratings: Machine Model = C Human Body Model = 3B

## **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>L</sub> = 100°C)	I <sub>F(AV)</sub>	3.0	Α
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	130	A
Operating Junction Temperature Range (Note 1)	TJ	- 65 to +175	°C

### THERMAL CHARACTERISTICS

Thermal Resistance, Junction–to–Lead $R_{\theta J}$	θJL 11	°C/W
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Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from Junction–to–Ambient:  $dP_D/dT_J < 1/R_{\theta,JA}$ .



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## SCHOTTKY BARRIER RECTIFIERS 3.0 AMPERES, 100 VOLTS



SMC CASE 403 PLASTIC

#### MARKING DIAGRAM



B310 = Specific Device Code A = Assembly Location

Y = Year WW = Work Week • = Pb-Free Package

(Note: Microdot may be in either location)

## ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MBRS3100T3	SMC	2500/Tape & Reel
MBRS3100T3G	SMC (Pb-Free)	2500/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

**Preferred** devices are recommended choices for future use and best overall value.

## **ELECTRICAL CHARACTERISTICS**

Rating	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 2) $ \begin{aligned} &(i_F=3.0\text{ A}, T_J=25^\circ\text{C})\\ &(i_F=6.0\text{ A}, T_J=25^\circ\text{C})\\ &(i_F=3.0\text{ A}, T_J=125^\circ\text{C})\\ &(i_F=6.0\text{ A}, T_J=125^\circ\text{C}) \end{aligned} $	V <sub>F</sub>	0.79 0.90 0.62 0.70	V
Maximum Instantaneous Reverse Current (Note 2) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 125^{\circ}C$ )	İR	0.05 5.0	mA

<sup>2.</sup> Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%.

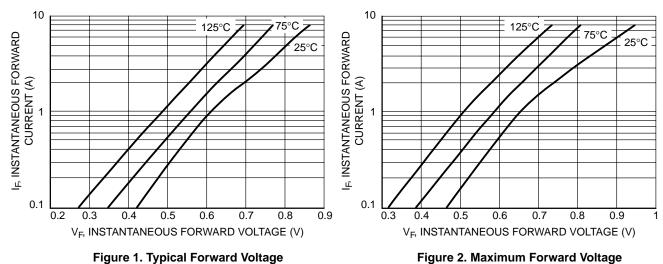


Figure 1. Typical Forward Voltage

1E-03

IE-04 CO-31 CO-31 (A) 10-31 CO-31 CO-31 (A)

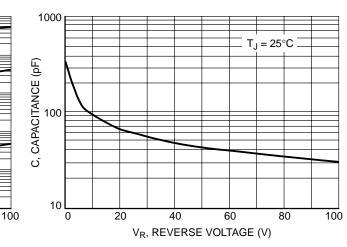
1E-08

125°C

= 75°C

= 25°C

20



V<sub>R</sub>, REVERSE VOLTAGE (V) **Figure 3. Typical Reverse Current** 

60

80

40

Figure 4. Typical Capacitance

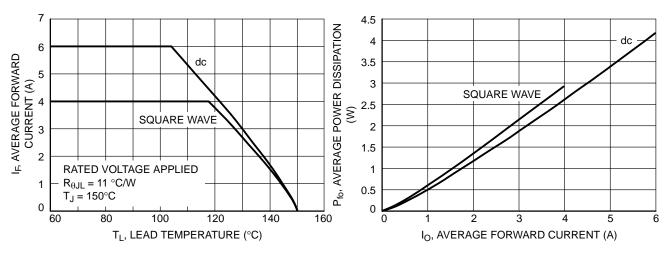
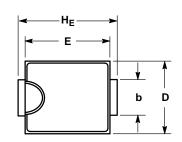


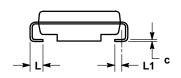
Figure 5. Current Derating - Lead

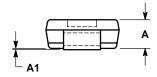
Figure 6. Forward Power Dissipation

#### PACKAGE DIMENSIONS

## SMC PLASTIC PACKAGE CASE 403-03 ISSUE E





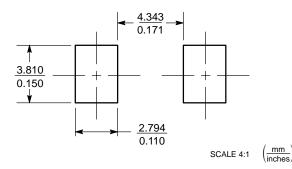


#### NOTES

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.
- CONTROLLING DIMENSION: INCH.
  D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.
- 403-01 THRU -02 OBSOLETE, NEW STANDARD 403-03.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	1.90	2.13	2.41	0.075	0.084	0.095
A1	0.05	0.10	0.15	0.002	0.004	0.006
b	2.92	3.00	3.07	0.115	0.118	0.121
С	0.15	0.23	0.30	0.006	0.009	0.012
D	5.59	5.84	6.10	0.220	0.230	0.240
E	6.60	6.86	7.11	0.260	0.270	0.280
HE	7.75	7.94	8.13	0.305	0.313	0.320
L	0.76	1.02	1.27	0.030	0.040	0.050
L1	0.51 REF			0.020 REF		

#### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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